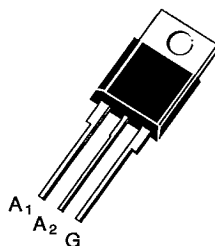


**TRIACS**

- GLASS PASSIVATED CHIP
- $I_{GT}$  SPECIFIED IN FOUR QUADRANTS


**TO 220 AB**  
 (Plastic)
**DESCRIPTION**

New range suited for applications such as phase control and static switching.

**ABSOLUTE RATINGS** (limiting values)

| Symbol             | Parameter                                                                            |                                    | Value                      | Unit                                     |
|--------------------|--------------------------------------------------------------------------------------|------------------------------------|----------------------------|------------------------------------------|
| $I_{T(RMS)}$       | RMS on-state Current (360° conduction angle)                                         | $T_C = 90\text{ }^{\circ}\text{C}$ | 15                         | A                                        |
| $I_{TSM}$          | Non Repetitive Surge Peak on-state Current ( $T_J$ initial = 25 °C - Half sine wave) | $t = 8.3\text{ ms}$                | 157                        | A                                        |
|                    |                                                                                      | $t = 10\text{ ms}$                 | 150                        |                                          |
| $I^2t$             | $I^2t$ Value for Fusing                                                              | $t = 10\text{ ms}$                 | 112.5                      | A <sup>2</sup> s                         |
| $di/dt$            | Critical Rate of Rise of on-state Current (1)                                        | Repetitive<br>$F = 50\text{ Hz}$   | 10                         | A/ $\mu$ s                               |
|                    |                                                                                      | Non Repetitive                     | 50                         |                                          |
| $T_{stg}$<br>$T_J$ | Storage and Operating Junction Temperature Range                                     |                                    | - 40 to 150<br>- 40 to 125 | $^{\circ}\text{C}$<br>$^{\circ}\text{C}$ |

| Symbol    | Parameter                             | BTB 15- |      |      |      |      | Unit |
|-----------|---------------------------------------|---------|------|------|------|------|------|
|           |                                       | 200B    | 400B | 600B | 700B | 800B |      |
| $V_{DRM}$ | Repetitive Peak off-state Voltage (2) | 200     | 400  | 600  | 700  | 800  | V    |

(1)  $I_G = 750\text{ mA}$   $di/dt = 1\text{ A}/\mu\text{s}$

(2)  $T_J = 125\text{ }^{\circ}\text{C}$ .

**THERMAL RESISTANCES**

| Symbol                  | Parameter                                                         | Value | Unit                        |
|-------------------------|-------------------------------------------------------------------|-------|-----------------------------|
| $R_{th(j-a)}$           | Junction to Ambient                                               | 60    | $^{\circ}\text{C}/\text{W}$ |
| $R_{th(j-c)}\text{ DC}$ | Junction to Case for DC                                           | 2.66  | $^{\circ}\text{C}/\text{W}$ |
| $R_{th(j-c)}\text{ AC}$ | Junction to Case for 360° Conduction Angle ( $F = 50\text{ Hz}$ ) | 2     | $^{\circ}\text{C}/\text{W}$ |

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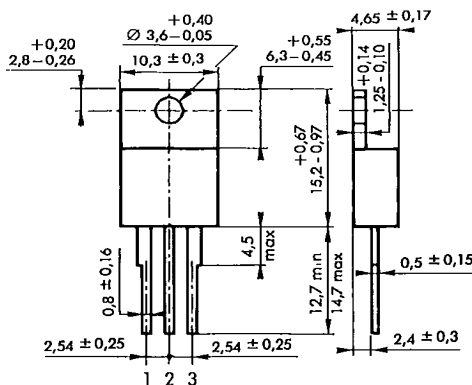
455

**GATE CHARACTERISTICS** (maximum values) $P_{GM} = 40 \text{ W}$  ( $t_p = 10 \mu\text{s}$ ) $I_{GM} = 4 \text{ A}$  ( $t_p = 10 \mu\text{s}$ ) $P_{G(AV)} = 1 \text{ W}$  $V_{GM} = 16 \text{ V}$  ( $t_p = 10 \mu\text{s}$ )*T-25-15***ELECTRICAL CHARACTERISTICS**

| Symbol        | Test Conditions                                                                                                               | Quadrants   | Min. | Typ. | Max. | Unit             |
|---------------|-------------------------------------------------------------------------------------------------------------------------------|-------------|------|------|------|------------------|
| $I_{GT}$      | $T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \Omega$<br>Pulse Duration $> 20 \mu\text{s}$                          | I-II-III    |      |      | 50   | mA               |
|               |                                                                                                                               | IV          |      |      | 75   |                  |
| $V_{GT}$      | $T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \Omega$<br>Pulse Duration $> 20 \mu\text{s}$                          | I-II-III-IV |      |      | 1.5  | V                |
| $V_{GD}$      | $T_j = 125^\circ\text{C}$ $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$                                                         | I-II-III-IV | 0.2  |      |      | V                |
| $I_H^*$       | $T_j = 25^\circ\text{C}$ $I_T = 100 \text{ mA}$ Gate Open                                                                     |             |      |      | 50   | mA               |
| $I_L$         | $T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $I_G = 150 \text{ mA}$<br>Pulse Duration $> 20 \mu\text{s}$                     | I-III-IV    |      | 50   |      | mA               |
|               |                                                                                                                               | II          |      | 100  |      |                  |
| $V_{TM}^*$    | $T_j = 25^\circ\text{C}$ $I_{TM} = 21 \text{ A}$ $t_p = 10 \text{ ms}$                                                        |             |      |      | 1.5  | V                |
| $I_{DRM}^*$   | $V_{DRM}$ Specified $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$                                                     |             |      |      | 0.01 | mA               |
|               |                                                                                                                               |             |      |      | 2    |                  |
| $dv/dt^*$     | $T_j = 125^\circ\text{C}$ Gate Open<br>Linear Slope up to $V_D = 67\% V_{DRM}$                                                |             | 250  | 500  |      | V/ $\mu\text{s}$ |
| $(dv/dt)_c^*$ | $T_C = 90^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 21 \text{ A}$<br>$(di/dt)_c = 6.7 \text{ A/ms}$                               |             | 10   |      |      | V/ $\mu\text{s}$ |
| $t_{gt}$      | $T_j = 25^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 21 \text{ A}$<br>$I_G = 500 \text{ mA}$ $di_G/dt = 3.5 \text{ A}/\mu\text{s}$ | I-II-III-IV |      | 2    |      | $\mu\text{s}$    |

\* For either polarity of electrode  $A_2$  voltage with reference to electrode  $A_1$ .**PACKAGE MECHANICAL DATA**

TO 220 AB Plastic

Triac : 1 2 3 = A<sub>1</sub> A<sub>2</sub> G

Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g.

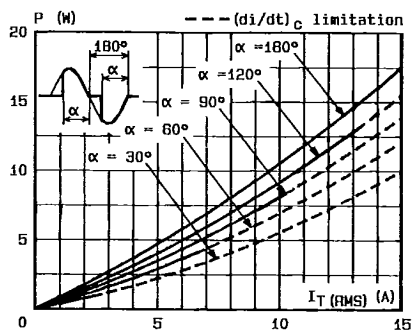


Fig.1 - Maximum mean power dissipation versus RMS on-state current ( $f = 60 \text{ Hz}$ ).

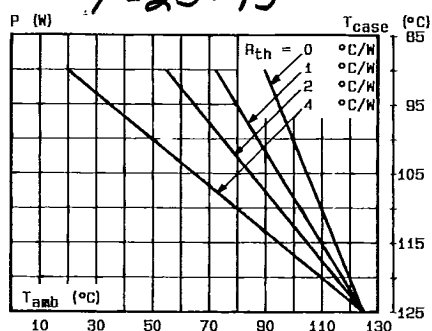


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.

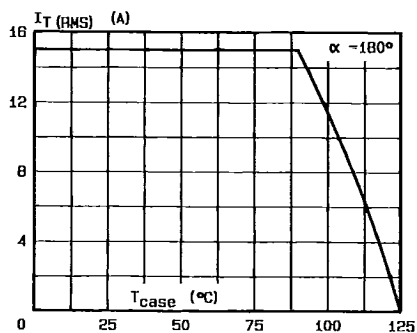


Fig.3 - RMS on-state current versus case temperature.

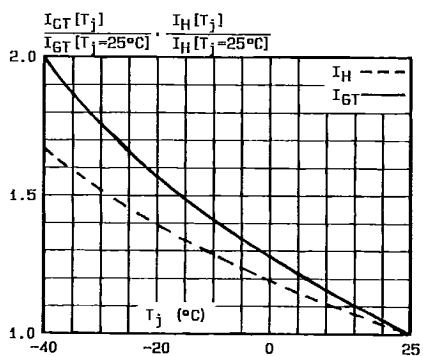


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

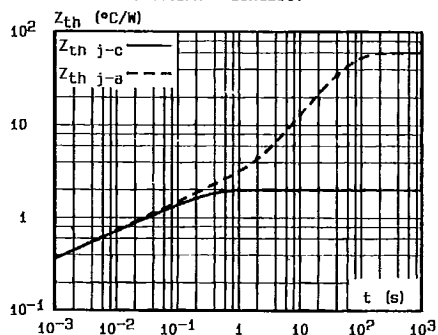


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

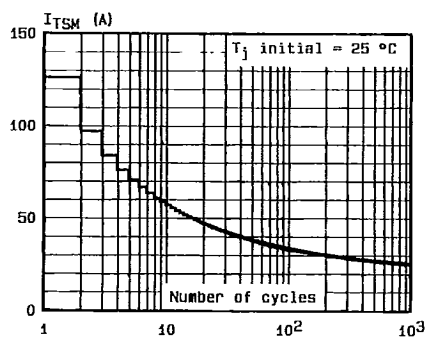


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

S G S-THOMSON

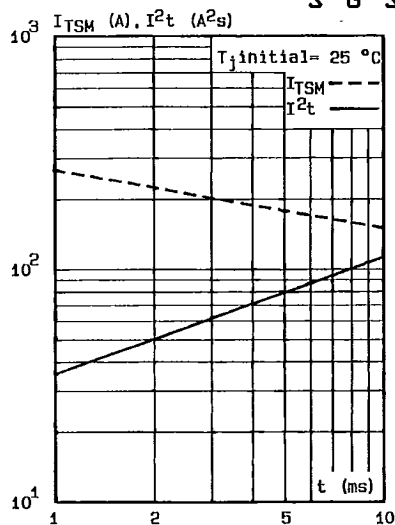


Fig. 7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width:  $t \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .

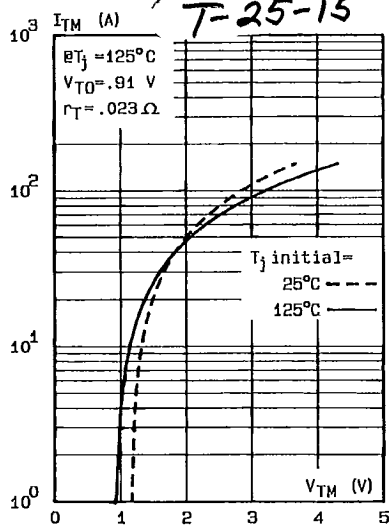


Fig. 8 - On-state characteristic (maximum values).